



DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office a	ddress and citizenship are as	stated below next to my name,	
•	•	one name is listed below) or an origin matter which is claimed and for which	
	ARTICLE OF MANUFACTUR ITCH FABRIC CHIPSET SYS	E FOR STORING AN INCOMING DA	ATAGRAM IN
the specification of which (o was amended on (if ap		ereto or was filed on as Appli	cation No and
•	eviewed and understand the cany amendment referred to a	contents of the above-identified speci above.	fication, including
i acknowledge the duty to d	lisclose all information which	is material to patentability as defined	in 37 CFR § 1.56.
patent or inventor's certification country other than the Unite	ite, or § 365(a) of any PCT In ed States, listed below and ha	119(a)-(d) or § 365(b) of any foreigr ternational application which designates ave also identified below any foreign that of the application on which prior	ated at least one application for
Prior Foreign Application(s)			Priority Claimed Yes No
Number	Country	Day/Month/Year Filed	
I hereby claim the benefit u	nder 35 U.S.C. § 119(e) of ar August 11, 2000	ny United States provisional applicati	on(s) below.
Application Number	Filing Date		
International application de the claims of this applicatio first paragraph of 35 U.S.C. patentability as defined in 3	signating the United States, lind is not disclosed in the prior § 112, I acknowledge the du	United States application(s), or § 365 isted below and, insofar as the subject United States application in the manuty to disclose all information which is available between the filing date of toplication:	ct matter of each of ner provided by the material to
Application Number	Filing Date	Status: Patented, Pending,	Abandoned
Application Number	Filing Date	Status: Patented, Pending,	Abandoned





I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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